

REMARKS

In the last Office Action, claims 2-5 were rejected under 35 U.S.C. §103(a) as being anticipated by U.S. Patent No. 5,914,763 to Fujii et al. ("Fujii") in view of U.S. Patent No. 5,737,272 to Uchiyama et al. ("Uchiyama"). The Examiner stated that Fujii discloses a display device in Figs. 1, 4-7 and 11-13 comprising an insulating glass substrate 311 on which a group of display electrodes 40, a group of wiring electrodes 41 and a group of connection pads are formed, the wiring electrodes being connected to the connection pads and arranged in at least one group, an opposing substrate 312 opposed to the insulating substrate 311, a display material contained in a spacing between the insulating substrate and the opposing substrate in a sealed manner, and a dummy electrode 45 provided on the insulating substrate adjacent an outermost wiring electrode of each group of wiring electrodes, the dummy electrode not being connected to any of the connection pads, wherein the display electrodes are transparent electrodes and the wiring electrodes are formed by plating portions of the transparent electrodes extending beyond a side edge of the opposing substrate.

The Examiner acknowledged that Fujii fails to disclose connection pads connected to the wiring electrodes, and that the wiring electrodes are metalized by plating only

portions of the transparent electrodes extending beyond a side edge of the opposing surface. Uchiyama was cited as disclosing metalization of wiring electrodes at a connection member 19 by plating only portions of transparent electrodes extending beyond a side edge of an opposing substrate for establishing electrical connections.

Applicants and applicants' undersigned attorney acknowledge with appreciation the Examiner's indication of allowable subject matter with respect to claim 9. In particular, the Examiner pointed out that the prior art does not disclose that the wiring electrodes and the dummy electrode are plated by non-electrolytic plating.

Applicants respectfully note that claim 9 was canceled by prior amendment and that the Examiner's discussion and indication of allowability pertains to claim 10, which recites the non-electrolytic plating.

In view of the Examiner's comments, applicants have amended independent claim 2 to incorporate the subject matter of dependent claim 10 by reciting that the wiring electrodes are plated by nonelectrolytic plating only portions of the transparent electrodes extending beyond a side edge of the opposing substrate. Claim 10 has been amended to recite that the nonelectrolytic plating is nonelectrolytic nickel plating.

Accordingly, applicants respectfully submit that claims 2-5 and 10 are in allowable form.

In view of the foregoing amendments and discussion, the application is now believed to be in condition for allowance. Accordingly, favorable reconsideration and allowance of the claims are most respectfully requested.

Respectfully submitted,

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Name

Signature

October 8, 2003

Date